PATENT ASSIGNMENT

Electronic Version v1.1 Stylesheet Version v1.1

SUBMISSION TYPE:	NEW ASSIGNMENT
NATURE OF CONVEYANCE:	ASSIGNMENT

CONVEYING PARTY DATA

Name	Execution Date
CHIH-HSIEN SUN	09/11/2007
CHENG-WEI CHANG	09/11/2007

RECEIVING PARTY DATA

Name:	FOXSEMICON INTEGRATED TECHNOLOGY, INC.
Street Address:	No. 16, Ke-Jung Rd., Science-Based Industrial Park
City:	Chu-Nan, Miao-Li Hsien
State/Country:	TAIWAN

PROPERTY NUMBERS Total: 1

Property Type	Number
Application Number:	11857400

CORRESPONDENCE DATA

Fax Number: (714)738-4649

Correspondence will be sent via US Mail when the fax attempt is unsuccessful.

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ATTORNEY DOCKET NUMBER: US14055

Jeffrey Todd Knapp

Total Attachments: 2

NAME OF SUBMITTER:

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PATENT REEL: 019844 FRAME: 0790

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ASSIGNMENT

In consideration of value received, the receipt and sufficiency of which are hereby acknowledged, the undersigned ASSIGNOR(S)

1.	Chih-Hsien Sun	_, residing at	Chu-Nan, Miao-Li, Taiwan
2.	Cheng-Wei Chang	, residing at	Chu-Nan, Miao-Li, Taiwan
3.		_, residing at	
4.		_, residing at	
5.		_, residing at	
6.		_, residing at	
7.		_, residing at	
8.		_, residing at	
6. 7.		, residing at , residing at	

hereby sell(s), assign(s) and transfer(s) unto: FOXSEMICON INTEGRATED TECHNOLOGY, INC. having a principal place of business at No. 16, Ke-Jung Rd., Science-Based Industrial Park, Chu-Nan, Miao-Li Hsien, Taiwan 350, R.O.C. hereafter designated "ASSIGNEE" the entire right, title and interest for the United States of America as defined in 35 U.S.C. 100, in the invention and all patent applications including any and all divisions, continuations, substitutes, and reissues thereof, and all resulting patents, known as LIGHT SOURCE MODULE WITH HIGH HEAT-DISSIPATION EFFICIENCY for which the undersigned

previously executed Ser. No.	and filing date of
[x] is executing concurrently herewith	

an application for Letters Patent of United States of America

AND the undersigned hereby authorize(s) and request(s) the United States Commissioner of Patents and Trademarks to issue said Letters Patent to the said ASSIGNEE, for its interest as ASSIGNEE, its successors, assigns and legal representatives; the undersigned agree(s) that the attorneys of record in said application, if any, shall hereafter act on behalf of said ASSIGNEE;

AND the undersigned hereby agree(s) to testify and execute any papers for ASSIGNEE, its successors, assigns and legal representatives, deemed essential by ASSIGNEE to ASSIGNEE's full protection and title in and to the invention hereby transferred.

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PATENT REEL: 019844 FRAME: 0791

1.	Chih-Heien Sun	Sep.11,2007	
	Chih-Hsien Sun inventor	Date	Witness
2.	Cheng-Wei Chang Cheng-Wei Chang inventor	Sep.11,2007 Date	Witness
3.	inventor	Date	Witness
4.	inventor	Date	Witness
5.	inventor	Date	Witness
6.	inventor	Date	Witness
7.	inventor	Date	Witness
8.	inventor	Date	Witness